

3PI Servers TRS11-18 | Xeon D®

A rugged, secure, SWaP-C optimized 1U rack server delivering enhanced performance and ease of maintenance/management at the tactical edge.



18" depth and reduced height coupled with front I/O greatly reduces compute footprint while enabling easy cable management and serviceability within the smallest of spaces.



SoC-class CPU with built-in accelerators and low TDP enable quick processing and control of critical operations while minimizing thermal complications.



Tested to meet the toughest military standards to ensure the quality and reliability of our solutions within the harshest of environments.



Overview

Compact, rugged, and secure, the TRS11-18 delivers enhanced performance in a short-depth 1U rack server with front I/O for streamlined accessibility and management.

Ideal for subsurface deployments (e.g., submarines) where space is limited, it enables quick modifications and repairs, significantly reducing downntime. Handle mission-critical data and ensure precise execution to effectively engage with enemy threats.

SOLUTION HIGHLIGHTS



Intel® Software Guard Extensions provide chip-based protections and isolation of critical data down to the application level.



Reduce time to market to take advantage of the latest technologies as they become available and maximize operational efficiency.



TAA-Compliance is achieved because all components are sourced from approved vendors to ensure complete system integrity when and where it matters most.

Our 3PI Servers are customizable per your most complex application or program requirements. Designed to support additional customer-specified option cards including high-end NVIDIA GPUs.



Technical Overview

SPECIFICATION	DETAILS
CPUs	Single Intel® Xeon® D
Memory	2x DDR4 2666/2400 MT/s ECC/non-ECC DDR4 RDIMM slots
Storage	1x M.2 NVMe, 1x SATA SSD (FIPS 140-2/3 available)
Form Factors	1U rack server (19" x 1.75" x 18" 48.26cm x 4.45cm x 45.72cm)
Network Interface	2x 25GbE, 2x 10GbE ports
PCIe Interconnect	1x PCIe 4.0 x8 slot, 1x PCIe 3.0 x4 slot or 4x SATA (via Oculink)
Power	1x 500W, 120/240vAC, internal, non-redundant

PROCESSORS (UP TO 10 CORES PER CPU)

Single Intel® Xeon® D CPU up to 90W TDP

Chipset: System on Chip, Intel® Xeon® D-1700 Series

*If an SKU higher than 250W is needed, contact a member of our team.

MEMORY (UP TO 128GB)

2x DDR4 2666/2400 MT/s ECC/non-ECC DDR4 RDIMM slots

SLOTS

1x PCle 4.0 x8 slot, 1x PCle 3.0 x4 slot or 4x SATA (via Oculink)

1/0

- ▶ USB: 4x USB ports: 2x USB2 ports via header, 2x USB3 ports via I/O
- ► IPMI: 1x ASPEED AST2600 BMC port
- ► Graphics: 1x ASPEED AST2600 BMC port
- ► Video: 1x VGA port
- ► LAN: 2x 25GbE SFP28 LAN ports via SoC, 2x 10GbE LAN ports with Intel® X550 10GBase-T Ethernet Controller
- ➤ Serial: 1x COM port

SECURITY

► TPM 2.0

COOLING (BMC Controlled)

3x 4-pin system fan headers

SYSTEM BIOS

- ► AMI 32MB SPI Flash EEPROM
 - ACPI 6.3
 - UEFI 2.7
 - SMBIOS 3.3
 - · Plug and Play (PnP)
 - PCI FW 3.0

SYSTEM MANAGEMENT (BMC)

ASPEED AST2600 baseboard management controller: rKVM, system monitoring, out-of-band management

OS COMPATIBILITY

- ▶ VxWorks
- ► Linux

*Contact us for the full compatabilities list

DIMENSIONS

Board: 6.75" x 6.75" (17.15cm x 17.15cm), Supermicro X12SDV-10C-SPT4F (Mini-ITX)

Chassis: 19" x 1.75" x 18" (48.26cm x 4.45cm x 45.72cm)

Weight: ~22lbs

ENVIRONMENTAL SPECIFICATIONS

- ► Operating Temperature: 0°C 50°C
- ► Storage Temperature: -40°C 85°C
- ► Operating Humidity: 85% (non-condensing)
- ▶ Shock: 20g, 11ms
- ► Vibration: 2.8 Grms

COMPLIANCE

Meets the following standards/certifications:

- ► MIL-STD-810H
- ► MIL-STD-461G
- ► IEC 62368-1:2014

*Environmental specifications and compliance are configuration dependent.
**Test reports and additional certifications available upon request.

Contact us for pricing and availability.

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^{*}For a comprehensive list of cybersecurity features, please contact one of our team members.